MAR 1 1 2003

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

- 1 -

#9/6, 3/18/3 Suda

Docket No. 0756-2351

			210
In re Patent Application of	)	Art Unit: 2812	Sun
Shunpei YAMAZAKI et al.	)	Examiner: V. Simkovic	$\mathcal{C}$
Serial No. 09/932,935	)		
Filed: August 21, 2001	)	CERTIFICATE OF MAILING	
For: LASER APPARATUS, LASER	)	I hereby certify that this correspondence is being dep The United States Postal Service with sufficient post	Sufficient postage of First
ANNEALING METHOD, AND	)	Class Mail in an envelope addressed to: Commissioner Washington, D.C. 20231, on March 4, 2003.	for Patents,
MANUFACTURING METHOD OF A	) 7	Adele M. Stamper	
SEMICONDUCTOR DEVICE	)		

## <u>AMENDMENT</u>

Commissioner for Patents Washington, DC 20231

Sir:

In response to the Office Action dated October 4, 2002, please amend the above-identified application as follows:

IN THE CLAIMS:

Please add new claims 25-45 as follows:

--25. A method for manufacturing a semiconductor device comprising the steps of: forming a semiconductor film on an insulating surface; crystallizing the semiconductor film by irradiation of harmonic of a YVO<sub>4</sub>

patterning the crystallized semiconductor film to form a crystallized island-like semiconductor film; and

forming at least a channel region of a thin film transistor in the crystallized island-like semiconductor film,

wherein the harmonic of the  $YVO_4$  laser has a shape at an irradiation surface which has aspect ratio of 10 or more.

03/14/2003 NMOHAMM1 00000114 09932935

laser;

01 FC:1202 02 FC:1201

378.00 0